



ENVIRONMENTAL AND PACKAGE TESTING DATA FOR Cerquad

Stress	Sample Size	Device Hr./Cyc	Condition	Total Fails	Fail Percentage
HAST	110	11,000	130°C, 85%RH	0	0.00
Pressure Pot	110	10,560	121°, 15 PSIG	0	0.00
Solder DUNK	55	165	260°C, 10SEC	0	0.00
Solderability	30	240	883 M2003	0	0.00
Temp Cycle	110	55,000	-65°C-150°C	0	0.00